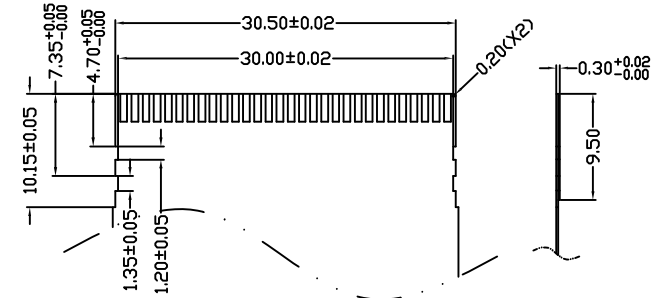


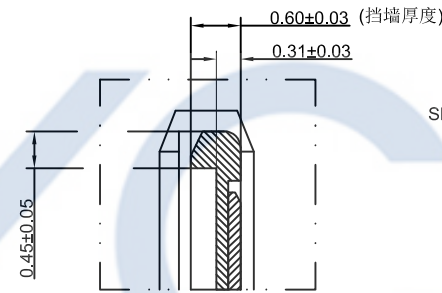
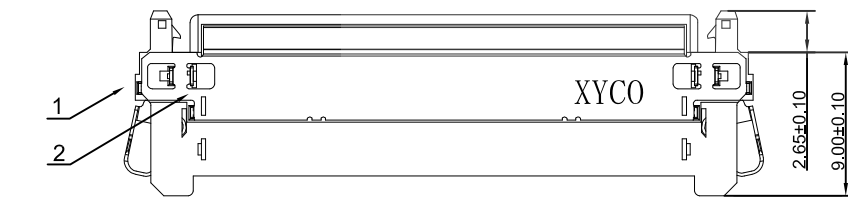
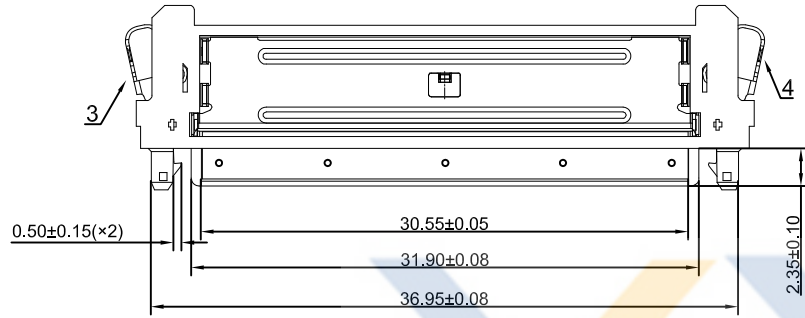
DRAWING FOR CUSTOMER

KB902-30 H L F 1 A-C1 X

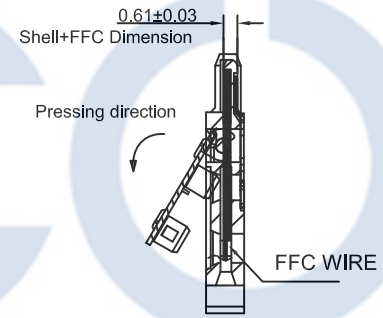
Pin No. _____ Logo _____
 Housing _____ Material _____
 With Lock _____ Version _____
 FFC TYPE _____ Mold No. _____



FFC WIRE

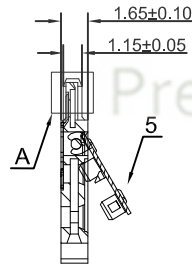


A - A
SCALE 4:1



FFC ASSEMBLY (REFERENCE)

SCALE 2:1



NO.	Name	Quantity	Material	Remark
5	30P Briquetting	1	SUS	stamping
4	30P Left Hook	1	SUS	stamping
3	30P Right Hook	1	SUS	stamping
2	30P Upper shell	1	SUS	stamping
1	30P Housing	1	LCP UL94V-0 (Beige)	shaping

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 TEL: 0769-8297 9981/2/3 http://www.XYCO.com.cn

DATE	VER	CHANGE HISTORY	CHANGED NAME	DRAWING	TOLERANCE	DRAWING	DESIGNER	PART NO.	DWG NO.
日期	版本	变更历史	修改后料号	变更者	公差	设计者		料号	图号
2015-09-12	A-1	功能区改为5孔, 旋转铁壳省去三角符号	KB902-30HLF1A-C1X	Devin	.X=±0.30 .XX=±0.20 .XXX=±0.10	Devin	KB902-30HLF1A-C1X		PE2111A
2014-11-15	A		KB902-30HLF1A-C1X	Devin		Thomas			
				William					

UNIT	PRODUCT NAME	REMARK
单位	产品名称	
mm	FI-X PH1.00mm FFC Wire To Board	Housing with lock, FFC type, 内空30.5